

GaAs INTEGRATED CIRCUIT

μ PG2158T5K

L, S-BAND SPDT SWITCH

DESCRIPTION

The μ PG2158T5K is a GaAs MMIC for L, S-band SPDT (<u>S</u>ingle <u>P</u>ole <u>D</u>ouble <u>T</u>hrow) switch which was developed for mobile phone and another L, S-band application.

This device can operate 2 control switching by control voltage 1.8 to 5.3 V. This device can operate frequency from 0.05 to 3.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (<u>Thin Shrink Small Out-line Non-leaded</u>) package. And this package is able to high-density surface mounting.

FEATURES

Switch control voltage

 Vcont (H) = 1.8 to 5.3 V (2.7 V TYP.)
 Vcont (L) = -0.2 to +0.2 V (0 V TYP.)

 Low insertion loss

 Lins1 = 0.40 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 Lins2 = 0.45 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 Lins3 = 0.47 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 Lins4 = 0.53 dB TYP. @ f = 2.5 to 3.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 ISL1 = 27 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 ISL2 = 19 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 ISL3 = 17 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
 ISL4 = 17 dB TYP. @ f = 2.5 to 3.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V

• Handling power : $P_{in (0.1 dB)} = +29.0 dBm TYP$. @ f = 2.0/2.5 GHz, $V_{cont (H)} = 2.7 V$, $V_{cont (L)} = 0 V$: $P_{in (1 dB)} = +30.5 dBm TYP$. @ f = 2.0/2.5 GHz, $V_{cont (H)} = 2.7 V$, $V_{cont (L)} = 0 V$

• High-density surface mounting: 6-pin plastic TSSON package (1.0 × 1.0 × 0.37 mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- W-LAN, WLL and BluetoothTM etc.

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2158T5K-E2	μPG2158T5K-E2-A	6-pin plastic TSSON (Pb-Free) Note	G2	Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 5 kpcs/reel

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office.

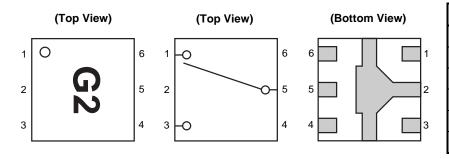
Part number for sample order: μPG2158T5K-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Document No. PG10578EJ02V0DS (2nd edition) Date Published December 2005 CP(K) The mark ★ shows major revised points.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V _{cont} 2
5	INPUT
6	V _{cont} 1

TRUTH TABLE

V _{cont} 1	V _{cont} 2	INPUT-OUTPUT1	INPUT-OUTPUT2
Low	High	OFF	ON
High	Low	ON	OFF

ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 Note	V
Input Power	Pin	+31	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

Note $|V_{cont}1 - V_{cont}2| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont (H)}	1.8	2.7	5.3	V
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	+0.2	V

ELECTRICAL CHARACTERISTICS 1

(TA = +25°C, Vcont (H) = 2.7 V, Vcont (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz Note 1	-	0.40	0.45	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.45	0.50	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.47	0.55	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.53	0.60	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz Note 1	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz Note 1	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz Note 1	15	20	-	dB
0.1 dB Loss Compression	Pin (0.1 dB)	f = 2.0/2.5 GHz	+26.0	+29.0	-	dBm
Input Power Note 2		f = 0.5 to 3.0 GHz	-	+29.0	-	
1 dB Loss Compression Input Power Note 3	Pin (1 dB)	f = 0.5 to 3.0 GHz	-	+30.5	-	dBm
2nd Harmonics	2f ₀	f = 2.0/2.5 GHz, Pin = +20 dBm	65	75	-	dBc
3rd Harmonics	3fo	f = 2.0/2.5 GHz, Pin = +20 dBm	65	75	-	dBc
Input 3rd Order Distortion Intercept Point	IIP ₃	f = 0.5 to 3.0 GHz 2 tone 5 MHz spacing	-	+60	-	dBm
Switch Control Current	Icont	No signal	-	0.2	20	μА
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	50	500	ns

- Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz
 - 2. Pin (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.
 - **3.** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

ELECTRICAL CHARACTERISTICS 2

(TA = +25°C, Vcont (H) = 1.8 V, Vcont (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz Note 1	-	0.40	0.47	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	_	0.46	0.52	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.48	0.57	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	_	0.54	0.62	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz Note 1	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz Note 1	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz Note 1	15	20	-	dB
0.1 dB Loss Compression	Pin (0.1 dB)	f = 2.0/2.5 GHz	+19.0	+22.0	-	dBm
Input Power Note 2		f = 0.5 to 3.0 GHz	_	+22.0	-	
1 dB Loss Compression Input Power Note 3	Pin (1 dB)	f = 0.5 to 3.0 GHz	-	+25.0	-	dBm
Switch Control Current	Icont	No signal	_	0.2	20	μА
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	50	500	ns

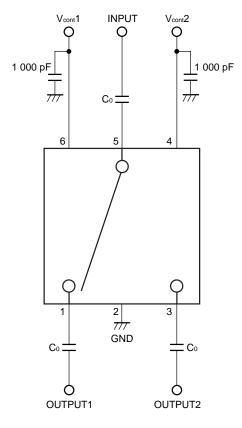
Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz

- 2. Pin (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.
- **3.** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

EVALUATION CIRCUIT

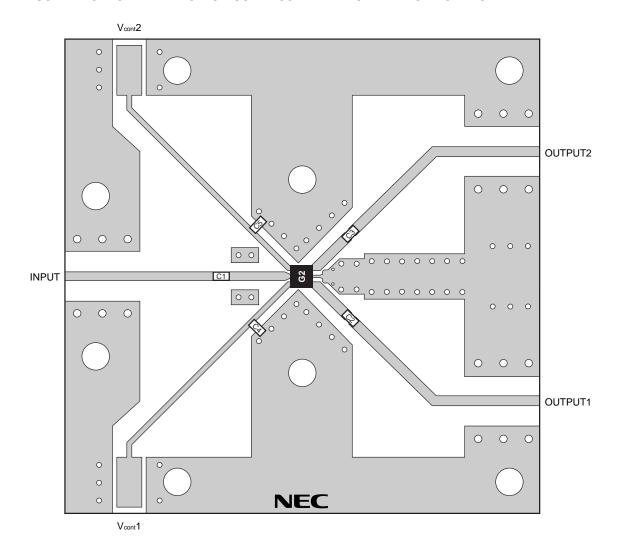


 $\textbf{Remark} \hspace{0.5cm} C_0 \hspace{0.2cm} : 0.05 \hspace{0.1cm} to \hspace{0.1cm} 0.5 \hspace{0.1cm} GHz \hspace{0.1cm} 1 \hspace{0.1cm} 000 \hspace{0.1cm} pF$

: 0.5 to 3.0 GHz 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

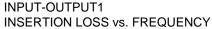
ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

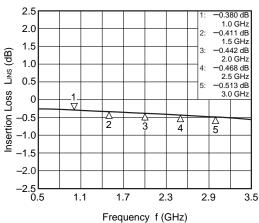


USING THE NEC EVALUATION BOARD

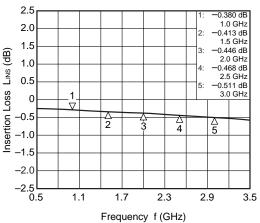
Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

TYPICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, $V_{cont}(H) = 2.7 \text{ V}$, $V_{cont}(L) = 0 \text{ V}$, DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)

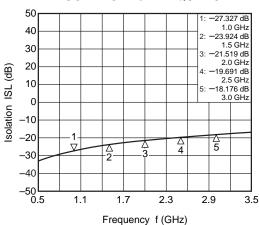




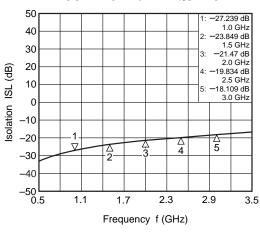
INPUT-OUTPUT2 INSERTION LOSS vs. FREQUENCY



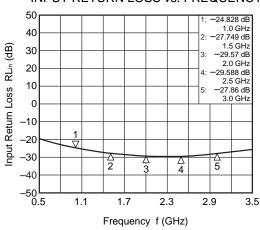
INPUT-OUTPUT1 ISOLATION vs. FREQUENCY



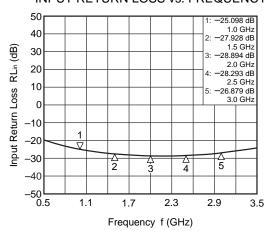
INPUT-OUTPUT2 ISOLATION vs. FREQUENCY



INPUT-OUTPUT1 INPUT RETURN LOSS vs. FREQUENCY

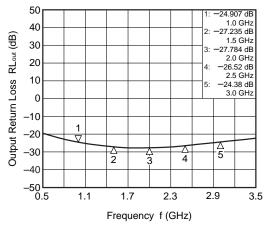


INPUT-OUTPUT2 INPUT RETURN LOSS vs. FREQUENCY

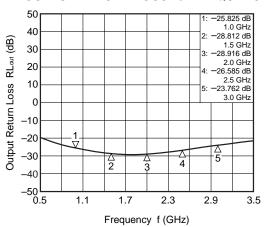


Remark The graphs indicate nominal characteristics.

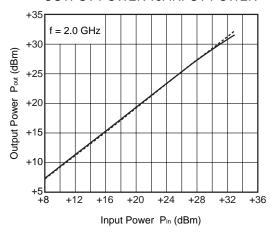
INPUT-OUTPUT1 OUTPUT RETURN LOSS vs. FREQUENCY



INPUT-OUTPUT2 OUTPUT RETURN LOSS vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER

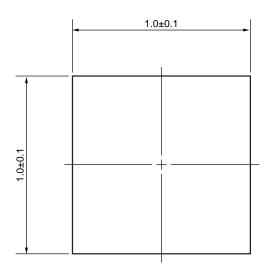


Remark The graphs indicate nominal characteristics.

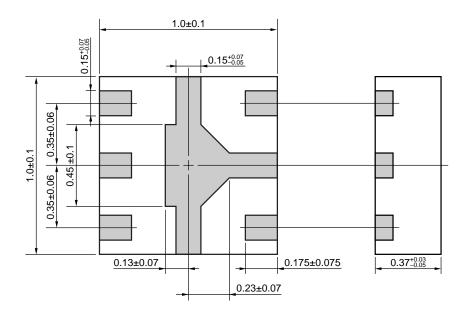
★ PACKAGE DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

(Top View)



(Bottom View)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	W\$260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration in CEL	on contained devices	
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)		
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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